



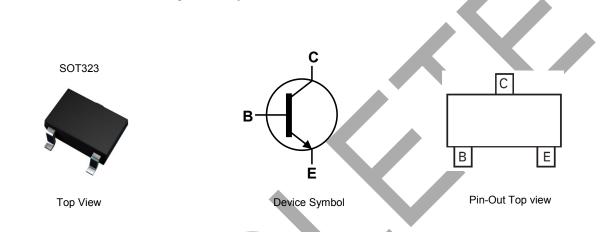
25V NPN SMALL SIGNAL TRANSISTOR IN SOT323

Features

- BV_{CEO} > 25V
- I_C = 200mA Collector Current
- **Epitaxial Planar Die Construction**
- Ultra-Small Surface Mount Package
- Complementary PNP Type: MMST4126
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic "Green" Molding Compound; UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads; Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.006 grams (Approximate)



Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
MMST4124-7-F	Standard	K1B	7	8	3,000

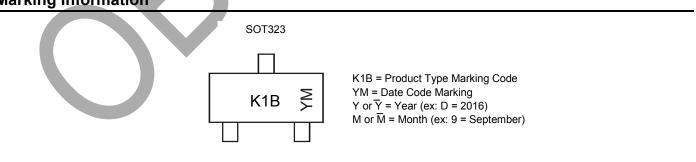
Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Date Code	Key													
Year	201	6	20	017	2018	2019	2020	2021	2022	2 20	23	2024	2025	2026
Code	D			E	F	G	Н		J	ł	<	L	М	Ν
Month	h	Ja	an	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code)	1	1	2	3	4	5	6	7	8	9	0	Ν	D



Absolute Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	30	V
Collector-Emitter Voltage	V _{CEO}	25	V
Emitter-Base Voltage	V _{EBO}	5.0	V
Collector Current	lc	200	mA

Thermal Characteristics (@T_A = +25°C unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

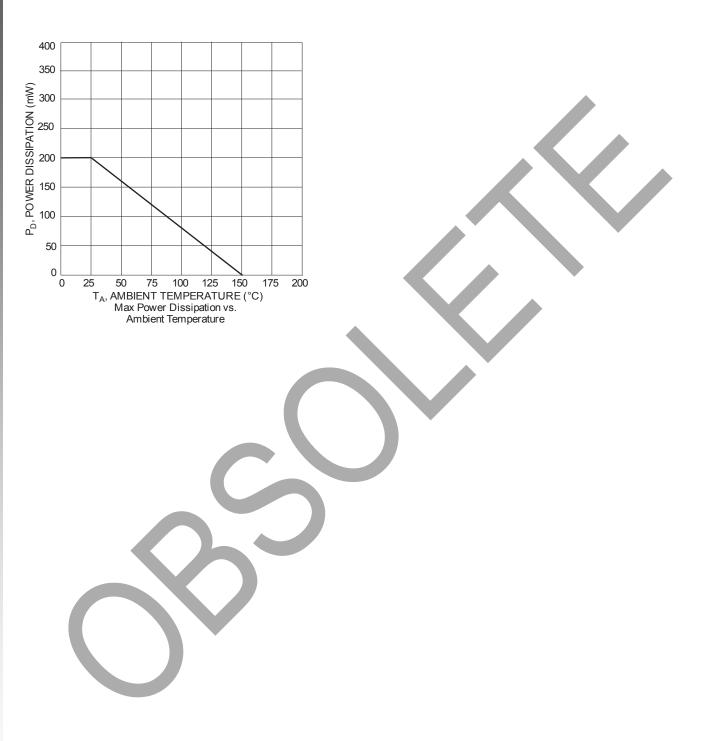
ESD Ratings (Note 6)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

5. For a device mounted with the collector lead on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR-4 PCB; device is Notes: measured under still air conditions whilst operating in a steady-state. 6. Refer to JEDEC specification JESD22-A114 and JESD22-A115



Thermal Characteristics and Derating Information





Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

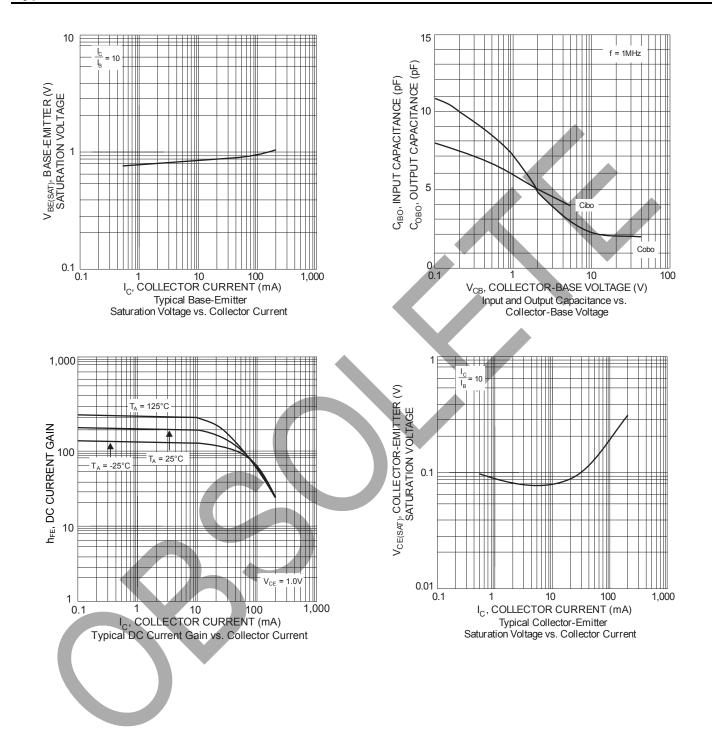
Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)					
Collector-Base Breakdown Voltage	BV _{CBO}	30	_	V	I _C = 10μA, I _E = 0
Collector-Emitter Breakdown Voltage	BV _{CEO}	25	_	V	$I_{\rm C} = 1$ mA, $I_{\rm B} = 0$
Emitter-Base Breakdown Voltage	BV _{EBO}	5	_	V	I _E = 10μA, I _C = 0
Collector Cut-Off Current	I _{CBO}		50	nA	$V_{CB} = 20V, I_E = 0$
Base Cut-Off Current	I _{EBO}		50	nA	V_{EB} = 3.0V, I_{C} = 0
ON CHARACTERISTICS (Note 7)					•
DC Current Gain	h	120	_		$I_{C} = 2mA, V_{CE} = 1V$
	h _{FE}	60	—		I _C = 50mA, V _{CE} = 1V
Collector-Emitter Saturation Voltage	V _{CE(SAT)}	_	0.30	V	I _C = 50mA, I _B = 5mA
Base-Emitter Saturation Voltage	V _{BE(SAT)}	_	0.95	V	I _C = 50mA, I _B = 5mA
SMALL SIGNAL CHARACTERISTICS					·
Output Capacitance	C _{OBO}	_	4	pF	V _{CB} = 5.0V, f = 1.0MHz, I _E = 0
Input Capacitance	CIBO	_	8	pF	V _{EB} = 0.5V, f = 1.0MHz, I _C = 0
Small Signal Current Gain	h _{FE}	120	480	_	V _{CE} = 1.0V, I _C = 2mA, f = 1.0MHz
Current Gain-Bandwidth Product	fT	300	_	MHz	$V_{CE} = 20V, I_C = 10mA,$ f = 100MHz

OBSOLETE – PART DISCONTINUED

Note: 7. Measured under pulsed conditions. Pulse width \leq 300µs. Duty cycle \leq 2%.



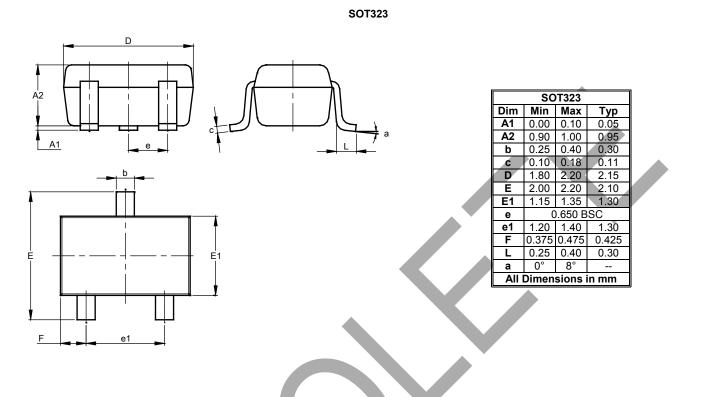
Typical Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)





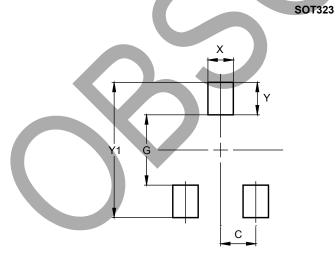
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)			
С	0.650			
G	1.300			
X	0.470			
Y	0.600			
Y1	2.500			



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